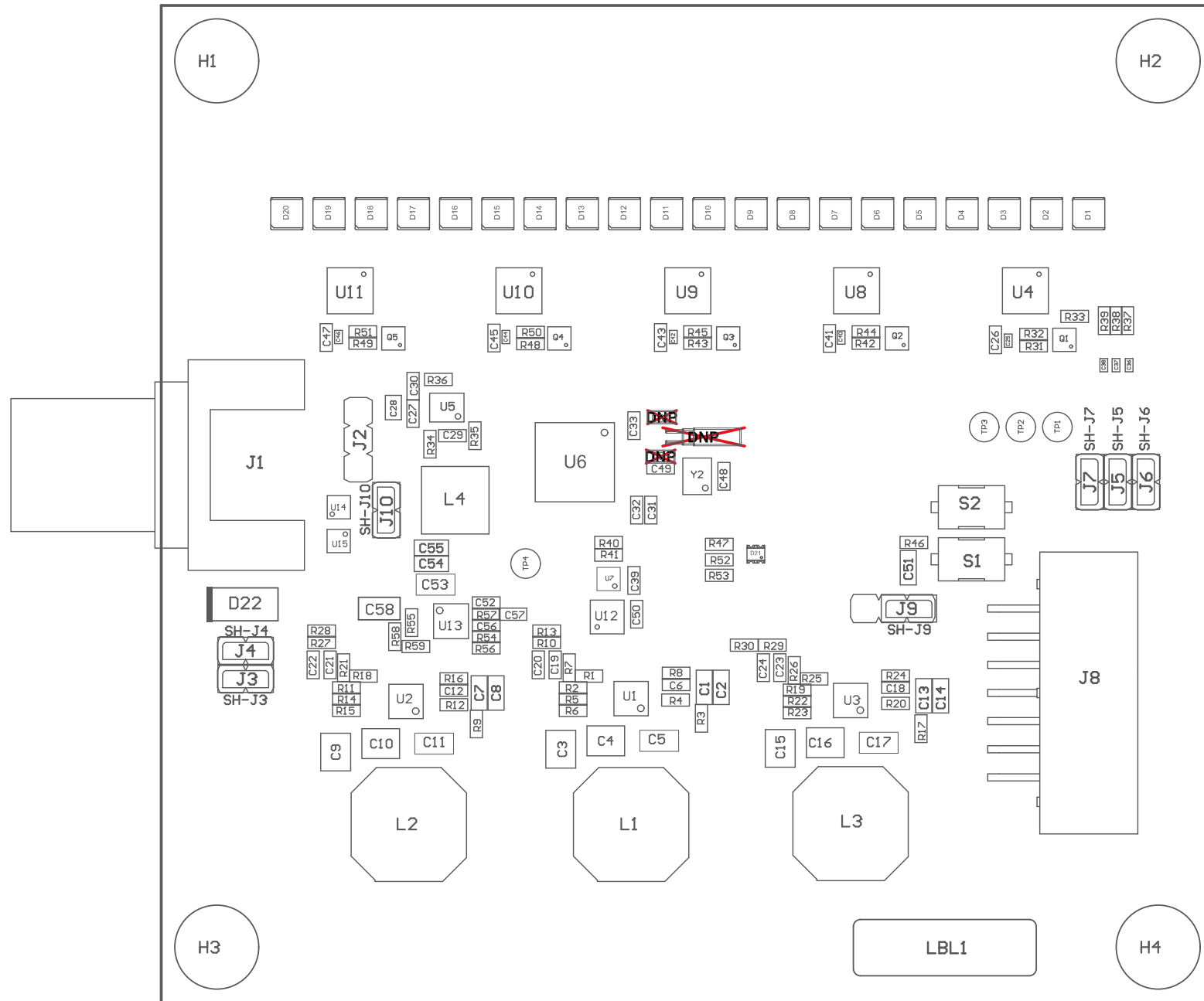
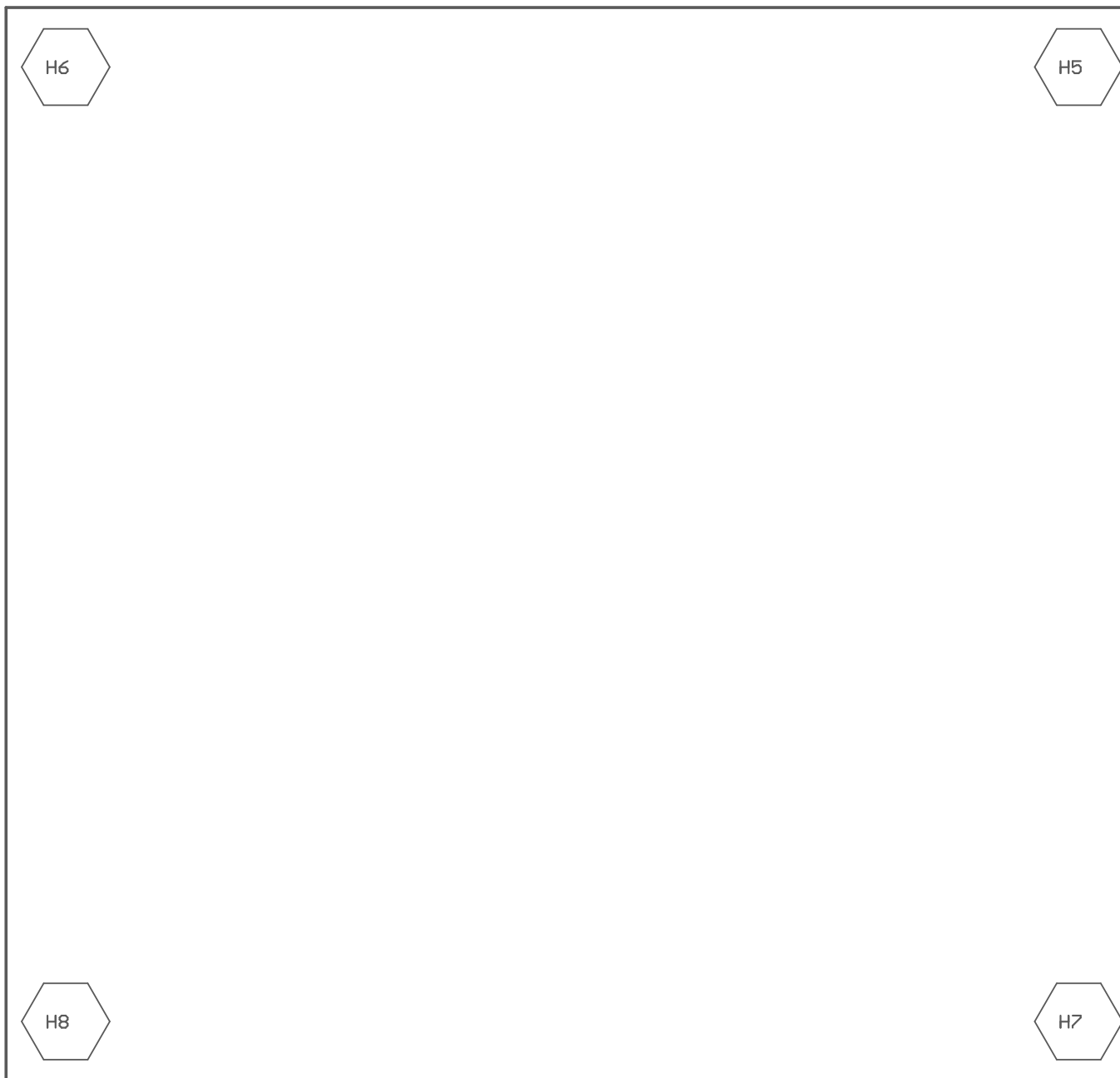


- ZZ7 ■ Place SH-J10 on J10 Pin 1-2
- ZZ6 ■ Place SH-J9 on J9 Pin 1-2
- ZZ5 ■ Place SH-J7 on J7 Pin 1-2
- ZZ4 ■ Place SH-J6 on J6 Pin 1-2
- ZZ3 ■ Place SH-J5 on J5 Pin 1-2
- ZZ2 ■ Place SH-J4 on J4 Pin 1-2
- ZZ1 ■ Place SH-J3 on J3 Pin 1-2



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
 ASSEMBLY VARIANT: 001

PCB VIEWED FROM TOP SIDE	BOARD #: TIDA-01437	REV: E2	SUN REV: Not In VersionControl
	TID #: TIDA-01437		
PLOT NAME = Top Assembly Drawing	GENERATED : 7/5/2017	11:03:46 AM	TEXAS INSTRUMENTS



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
ASSEMBLY VARIANT: 001

PCB VIEWED FROM BOTTOM SIDE	BOARD #: TIDA-01437	REV: E2	SUN REV: Not In VersionControl
	TID #: TIDA-01437		
PLOT NAME = Bottom Assembly Drawing	GENERATED : 7/5/2017	11:03:47 AM	TEXAS INSTRUMENTS

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